

# **UPC811**

# High Stability,

# Low Offset Voltage J-FET Input Operational Amplifier

### DESCRIPTION

UPC811 is a unique J-FET input operational amplifier that uses a high-speed PNP transistor ( $f_T = 300 \text{ MHz}$ ) for the output stage to achieve fast response and high stability.

The resistor-trimming method proven in other Renesas High-Precision Op-Amp and High-Precision reference voltage is incorporate in this Op-Amp input stage, thus producing an excellent low offset voltage characteristics that has surpasses conventional general purpose op-amp in spite of being J-FET input.

Along with this series of lineup, the dual type operational amplifier, UPC812 and 4092 with the same circuit configuration are also available.

# **FEATURES**

Input Offset Voltage ±1 mV (TYP.) (±2.5 mV MAX.)

 $\begin{array}{lll} \bullet & V_{IO} \ Temperature \ Drift & \pm 7 \ \mu V/^{\circ} C \ (TYP.) \\ \bullet & Input \ Bias \ Current & 50 \ pA \ (TYP.) \\ \bullet & Slew \ Rate & 15 \ V/\mu s \ (TYP.) \end{array}$ 

Unity Gain Frequency

4 MHz (TYP.))

Input Equivalent Noise Voltage Density

19 nV/√Hz (TYP.)

Input Equivalent Noise Voltage Density
19 nV/√Hz (TYP.) (f = 1 kHz)
Stable operation against capacitive load
(Capacitive Load at 10000 pF, AV = +1)

Built-In Phase Compensation Circuit

Built-In Output Short Circuit Protection

• Standard Single Op-Amp terminal connection (pin compatible)

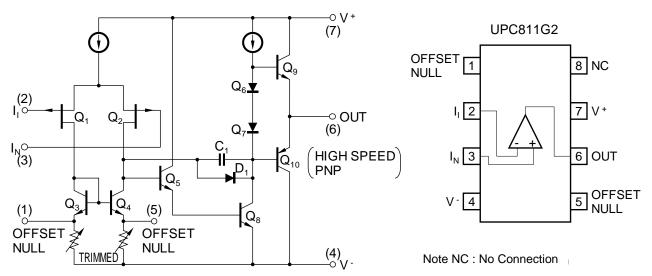
# ORDERING INFORMATION

Order Name (1)	Package			
UPC811G2-AP	8-Pin plastic SOP ( 5.72 mm ( 225 ))			

(1) Order names containing E1 or E2 indicate that the packaging format is embossed taping. Pin 1 of E1 is on draw-out side, and pin 1 of E2 is at take-up side.

#### **EQUIVALENT CIRCUIT**

# PIN CONFIGURATION (Top View)



# ABSOLUTE MAXIMUM RATINGS $(T_A = 25 \text{ °C})$

Parameter	Symbol	UPC811G2	Unit
Supply Voltage Note1	V+ - V-	-0.3 ~ +36	V
Differential Input Voltage	V <sub>ID</sub>	±30	V
Input Voltage Note 2	Vı	V <sup>-</sup> -0.3 ~ V <sup>+</sup> +0.3	V
Output Applied Voltage Note3	Vo	V <sup>-</sup> -0.3 ~ V <sup>+</sup> +0.3	V
Total Power Dissipation Note4	PT	440	mW
Output Short Circuit Duration Note5		Indefinite	S
Operating Ambient Temperature	T <sub>A</sub>	-40 ~ +85	°C
Storage Temperature	T <sub>stg</sub>	-55 ~ +125	°C

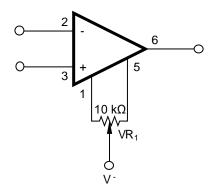
- [Note] 1. Note that reverse connections of the power supply may damage the ICs.
  - 2. The input terminal must be apply within the input voltage range to avoid deteriorating or damaging the device characteristic. Do not exceed the ratings including during transition state such as ON/OFF, etc. The Op-Amp input voltage must operates within the electrical characteristics range of input common-mode voltage.
  - **3.** The output terminal must be apply within the output voltage range to avoid deteriorating or damaging the device characteristic. Do not exceed the ratings including during transition state such as ON/OFF, etc. The Op-Amp output voltage must operates within the electrical characteristics range of maximum output voltage.
  - **4.** This is the value at  $T_A \le +25$  °C. De-rate value at -4.4 mW/°C when  $T_A > 25$  °C.
  - 5. Please use the total loss and the de-rating value from Note 4.

## RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Power Supply Voltage	V±	±5		±16	V
Load Current	lo			±10	mA
Load Capacitance	CL			10000 Note6	pF
(When $A_{\lor} = +1$ )	OL .			10000	P.

**[Note] 6.** This is the value when the feedback resistor ( $R_f$ ) = 0  $\Omega$ . The higher the  $R_f$  value, the more likely it is to oscillate due to the influence of the input capacitance. So connect a capacitor of about 100 pF in parallel with  $R_f$ .

## **OFFSET ADJUSTMENT METHOD**



**(Note)** OFFSET NULL pin should be open or connected to V <sup>-</sup> via a resistor as shown above. Any connection other than V <sup>-</sup> may cause malfunction, characteristics degradation or damage.

# ELECTRICAL CHARACTERISTICS ( $T_A = 25$ °C, $V^{\pm} = \pm 15$ V)

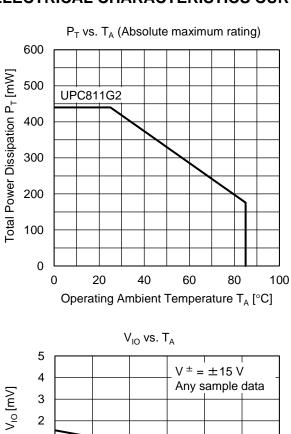
Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Test Condition
Input Offset Voltage	Vio		±1	±2.5	mV	R <sub>S</sub> ≤ 50 Ω
Input Offset Current Note7	lio		±25	±100	pА	
Input Bias Current Note7	I <sub>B</sub>		50	200	pА	
Large Signal Voltage Gain	Av	25	200		V/mW	$R_L \ge 2 \text{ k}\Omega, V_O = \pm 10 \text{ V}$
Circuit Current	Icc		2.5	3.4	mA	Io = 0 A
Common Mode Rejection Ratio	CMR	70	100		dB	
Supply Voltage Rejection Ratio	SVR	70	100		dB	
Output Voltage Swing	V <sub>om</sub>	±12	+14.0 -13.3		V	R <sub>L</sub> ≥ 10 kΩ
Output Voltage Swing	V <sub>om</sub>	±10	+13.5 -12.8		V	$R_L \ge 2 k\Omega$
Common Model Input Voltage Range	V <sub>ICM</sub>	±11	+14 -12		V	
Slew Rate	SR		15		V/µs	Av = 1
Unity Gain Frequency	f <sub>unity</sub>		4		MHz	
Input Equivalent Noise Voltage Density	en		19		nV/√Hz	Rs = 100 Ω, f = 1 kHz
Input Offset Voltage	Vio	•		±5	mV	R <sub>S</sub> $\leq$ 50 Ω, T <sub>A</sub> = -20 ~ +70 °C
Average V <sub>IO</sub> Temperature Drift	$\Delta V_{IO}/\Delta T$		±7		μV/°C	T <sub>A</sub> = -20 ~ +70 °C
Input Offset Current Note7	lio	•		±2	nA	T <sub>A</sub> = -20 ~ +70 °C
Input Bias Current Note7	I <sub>B</sub>			7	nA	T <sub>A</sub> = -20 ~ +70 °C

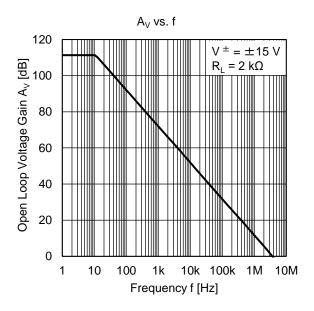
[Note] 7. The direction of the input bias current is the same direction that flows into the IC because the first stage is composed of Pch J-FET. When T<sub>J</sub> = 25°C or higher, it increases exponentially with increase in temperature (please see I<sub>B</sub> - T<sub>A</sub> characteristics). During measurement, please kindly take care of T<sub>J</sub> ≒ T<sub>A</sub>.

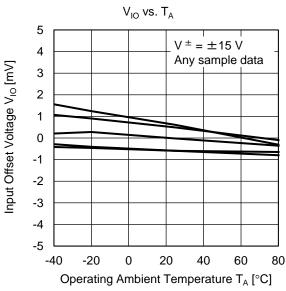
## Caution

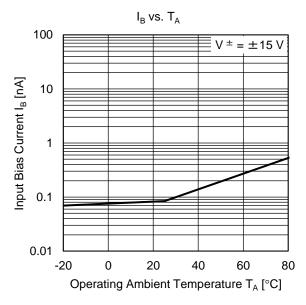
Since UPC811 has high input impedance characteristics, please be careful of insulation between the terminals on the board.

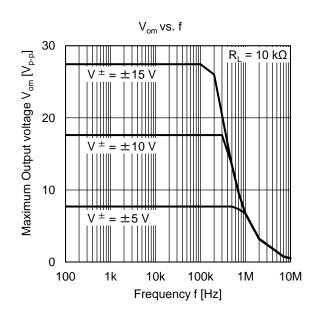
# **ELECTRICAL CHARACTERISTICS CURVE (TA = 25 °C, TYP.)**

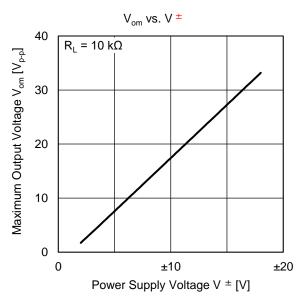


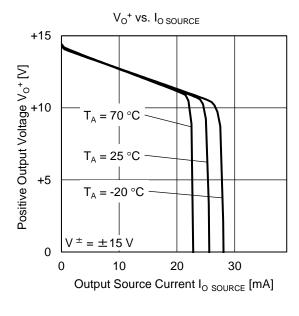


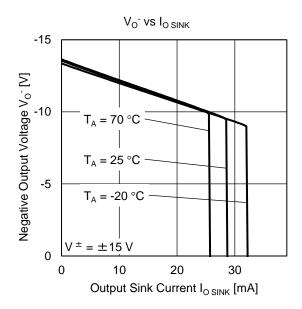


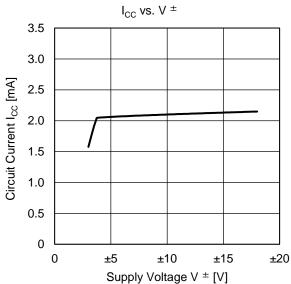


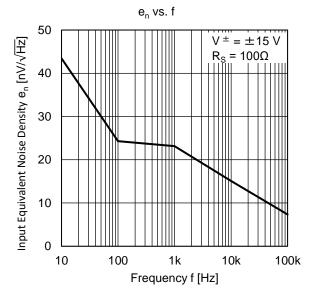


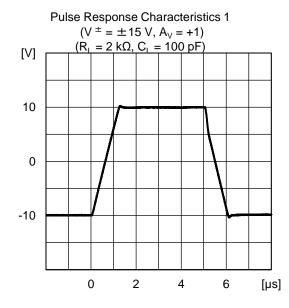


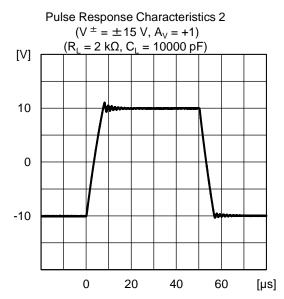












#### **USE WITH PRECAUTIONS**

#### • Power Supply (Dual Power Supply / Single Power Supply)

The op amp operates when a predetermine voltage is applied between  $V^+ - V^-$ . Therefore, while it operates from a single power supply ( $V^- = GND$ ), it is not possible to operate the input and output near GND. So please be careful of the common-mode input voltage range and maximum output voltage.

#### · Ratings of input/output pin voltage

When the voltage of input/output pin exceeds the absolute maximum rating, the parasitic diode within the IC may conduct, causing characteristics degradation or damage. In addition, if the input pin is lower than  $V^-$ , or the output pin exceeds the power supply voltage, it is recommended to make a clamping circuit using a diode with low forward voltage (e.g.: Schottky diode) as protection.

#### · Range of common-mode input voltage

When the supply voltage does not meet the condition of electrical characteristics, the range of common-mode input voltage is as follows.

$$V_{ICM}$$
 (TYP.) :  $V^- + 3 \sim V^+ - 1$  [V] ( $T_A = 25$  °C).

During designing, do include some margin by considering characteristics variation, temperature characteristics etc.

#### · Maximum output voltage

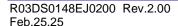
The TYP. value range of the maximum output voltage when the supply voltage does not meet the condition of electrical characteristics is as follows:

$$V_{om}^+$$
 (TYP.):  $V^+ - 1$  [V] ( $T_A = 25^{\circ}$ C),  $V_{om}^-$  (TYP.):  $V^- + 1.7$  [V] ( $T_A = 25^{\circ}$ C)

During designing, do include some margin by considering characteristics variation, temperature characteristics and so on. In addition, also note that the output voltage range  $(V_{om}^+ - V_{om}^-)$  will become narrow when the output current increases.

## · Handling of ICs

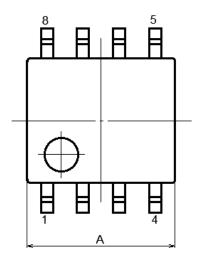
When stress is added to the ICs due to warpage or bending of a board, the characteristic may fluctuates due to piezoelectric (piezo) effect. Therefore, pay attention to warpage or bending of a board.



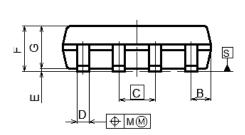
# **PACKAGE DRAWINGS**

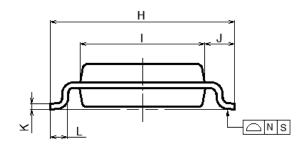
## **8-PIN PLASTIC SOP**

JEITA Package code	RENESAS code	MASS (TYP.) [g]
P-LSOP8-4.4×5.2-1.27	PLSP0008DE-A	0.09[g]









NOTE
EACH LEAD CENTERLINE IS LOCATED WITHIN 0.12 MM OF
ITS TRUE POSITION(T.P.) AT MAXIMUM MATERIAL CONDITION.

	(UNIT:mm)
ITEM	DIMENSIONS
Α	5.2±0.17
В	0.78MAX
С	1.27(T.P)
D E	0.40±0.05
Е	0.1±0.1
F	1.59±0.21
G	1.49
Н	6.5±0.3
I	4.4±0.1
J	1.05±0.15
K	0.2±0.07
L	0.6±0.20
M	0.1MAX
N	0.1MAX
Р	4°±4°

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